

MF3009, MF301x, MF302x



DESCRIPTION

The MF3009, MF301x and MF302x series of devices consist of a GaAs infrared emitting diode optically coupled to a light activated bilateral triac. They are designed for use with a discrete power triac in the control of resistive and inductive loads operating in 110 to 240 VAC lines.

FEATURES

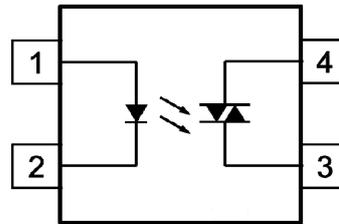
- Non Zero Crossing (Random Phase)
- V_{DRM}
MF3009 250V
MF301x 250V
MF302x 400V
- Isolation Voltage 3750V_{RMS}
- Wide Operating Temperature Range
-40°C to 110°C
- Pb Free and RoHS Compliant
- UL File E91231 for MF302x series.

APPLICATIONS

- Solenoid / Valve Controls
- Lamp Ballasts
- Light Dimming Controls
- AC Motor Drivers
- Temperature Controls
- Solid State Relays

ORDER INFORMATION

- Available in Tape & Reel



- 1 Anode
- 2 Cathode
- 3 Main Terminal 2
- 4 Main Terminal 1

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

| | |
|-------------------|-------|
| Forward Current | 60mA |
| Reverse Voltage | 6V |
| Power dissipation | 100mW |

Output

| | |
|-----------------------------------|-------|
| Off-state Output Terminal Voltage | |
| MF3009 | 250V |
| MF301x | 250V |
| MF302x | 400V |
| ON-state RMS Current | 70mA |
| Peak Repetitive Surge Current | 1A |
| Power Dissipation | 300mW |

Total Package

| | |
|-------------------------------------|----------------------|
| Isolation Voltage | 3750V _{RMS} |
| Operating Temperature | -40 to 110 °C |
| Storage Temperature | -55 to 150 °C |
| Lead Soldering Temperature (10s) | 260°C |

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

INPUT

| Parameter | Symbol | Test Condition | Min | Typ. | Max | Unit |
|-----------------|--------|---------------------|-----|------|-----|---------------|
| Forward Voltage | V_F | $I_F = 10\text{mA}$ | | 1.2 | 1.5 | V |
| Reverse Current | I_R | $V_R = 6\text{V}$ | | | 10 | μA |

OUTPUT

| Parameter | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|------------------|---|---------------------------|------|-----|------------------|
| Peak Off-state Current Either Direction | I_{DRM} | $V_{\text{DRM}} = \text{Rated } V_{\text{DRM}}$ $I_F = 0\text{mA}$ (Note 1) | | | 100 | nA |
| Peak Blocking Voltage | V_{DRM} | $I_{\text{DRM}} = 100\text{nA}$ MF3009 MF3010 / MF3011 / MF3012 MF3020 / MF3021 MF3022 / MF3023 MF3024 | 250 250 400 | | | V |
| Peak On-state Voltage Either Direction | V_{TM} | $I_{\text{TM}} = 100\text{mA Peak}$ $I_F = \text{Rated } I_{\text{FT}}$ | | | 2.5 | V |
| Critical Rate of Rise of Off-state Voltage | dv/dt | $I_F = 0\text{mA}$ | | 10 | | V/ μs |



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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)

COUPLED

| Parameter | Symbol | Test Condition | Min | Typ. | Max | Unit |
|-------------------------------------|----------|---|-----|------|--------------------------|---------|
| Input Trigger Current | I_{FT} | $V_{TM} = 3V$ MF3009 / MF3020 MF3010 / MF3021 MF3011 / MF3022 MF3012 / MF3023 MF3024 (Note 2) | | | 30 15 10 5 3 | mA |
| Holding Current Either Direction | I_H | | | 3 | 5 | mA |
| Turn-on Time | t_{ON} | $V_O = 6V,$ $R_L = 100\Omega,$ $I_F = 20mA$ | | | 100 | μs |

ISOLATION

| Parameter | Symbol | Test Condition | Min | Typ. | Max | Unit |
|-------------------|-----------|---|------|------|-----|-----------|
| Isolation Voltage | V_{ISO} | R.H. = 40% - 60%, $t = 1 \text{ min}$ (Note 3) | 3750 | | | V_{RMS} |

Note 1 : Test Voltage must be applied within dv/dt rating.

Note 2 : Guaranteed to trigger at an I_F value less than or equal to max I_{FT} ,
recommended I_F lies between Rated I_{FT} to Absolute Max I_F .

Note 3 : Measured with input leads shorted together and output leads shorted together.

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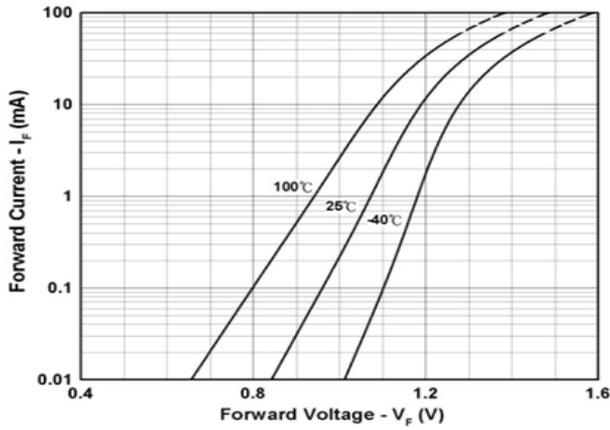


Fig 1 Forward Current vs Forward Voltage

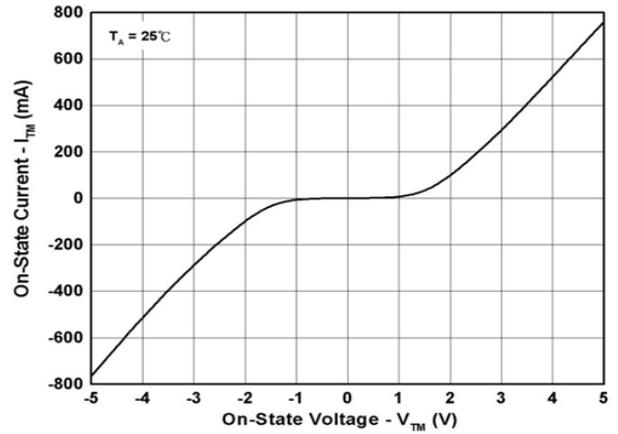


Fig 2 On-State Characteristics

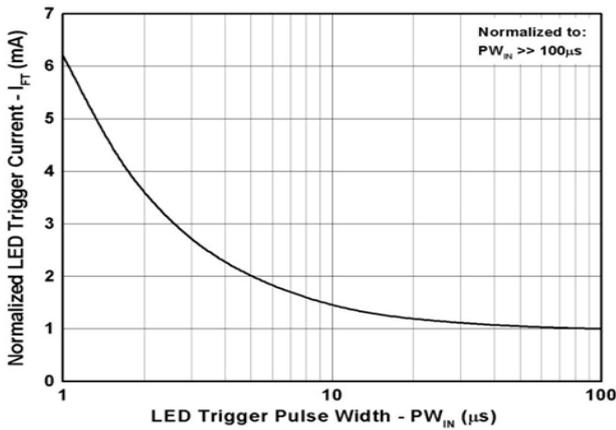


Fig 3 Normalized LED Trigger Current vs Trigger Pulse Width

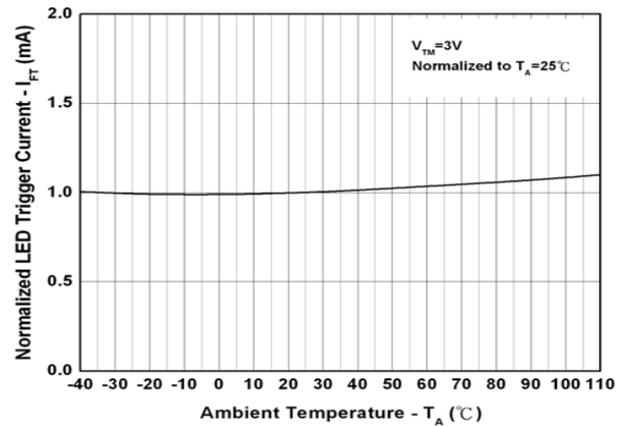


Fig 4 Normalized LED Trigger Current vs Ambient Temperature

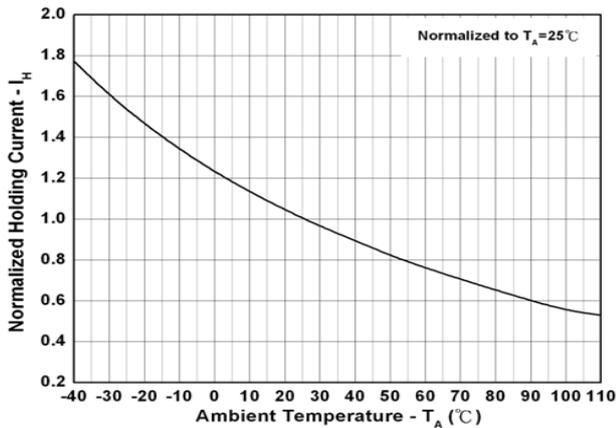


Fig 5 Normalized Holding Current vs Ambient Temperature

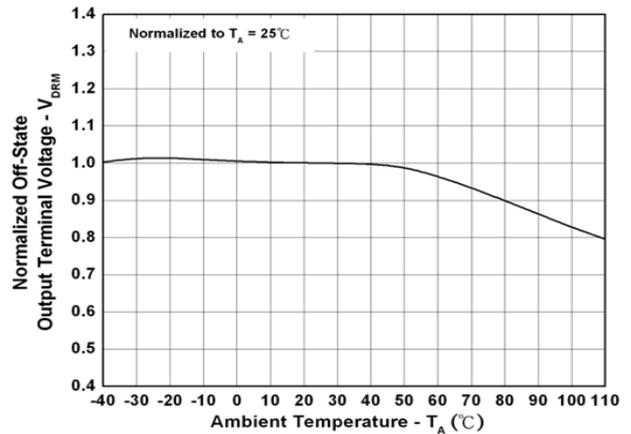


Fig 6 Normalized Off-State Output Terminal Voltage vs Ambient Temperature

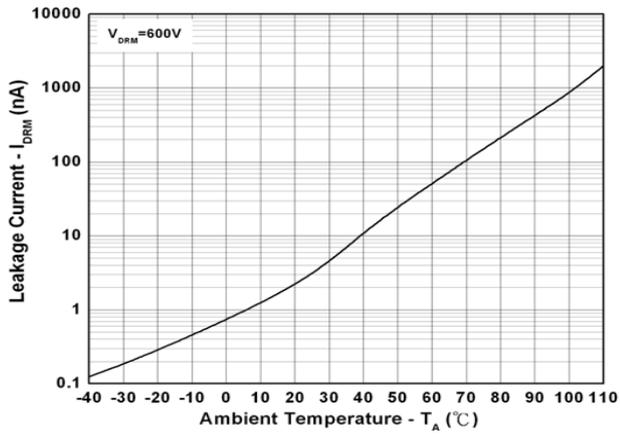
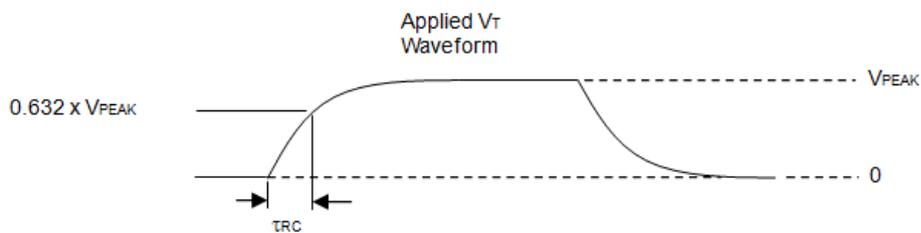
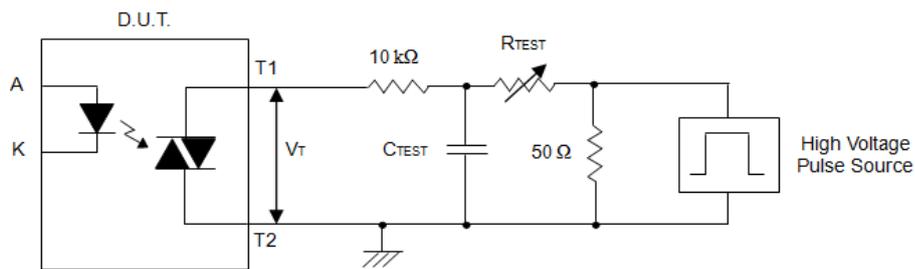


Fig 7 Leakage Current vs Ambient Temperature



$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

Fig 8 Static dv/dt Test Circuit

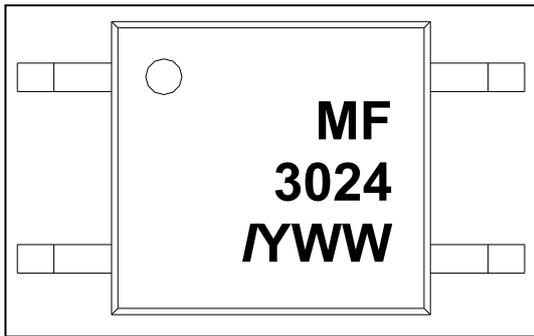
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ORDER INFORMATION

| MF3009, MF301x, MF302x | | | |
|--|---|---------------------------|-------------------|
| After PN | PN | Description | Packing quantity |
| None | MF3009 MF3010, MF3011, MF3012 MF3020, MF3021, MF3022, MF3023, MF3024 | Surface Mount Tape & Reel | 3000 pcs per reel |
| NOTE : MF3024 may be supported when ordering any of the following Part Numbers, MF3009, MF3010, MF3011, MF3012, MF3020, MF3021, MF3022, MF3023. | | | |

DEVICE MARKING

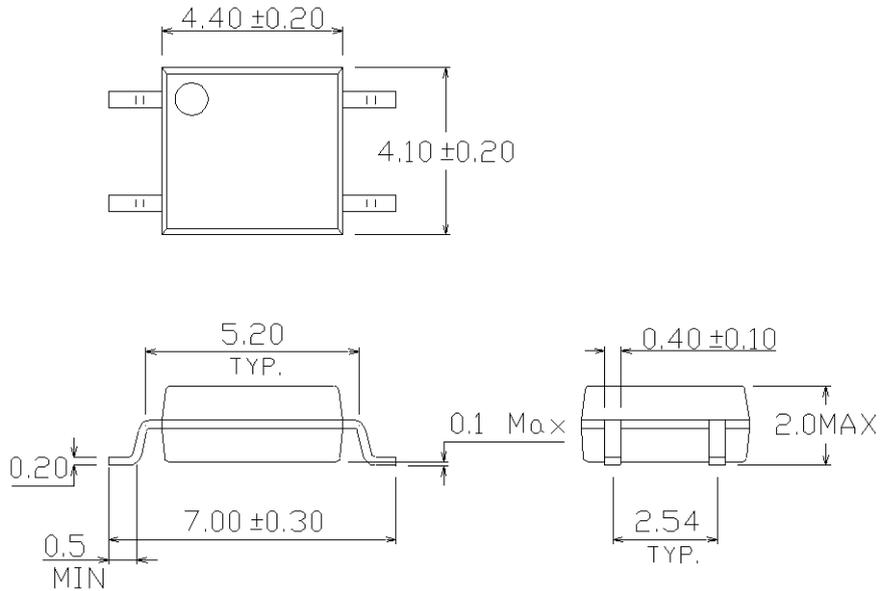
Note : MF3024 is used as example



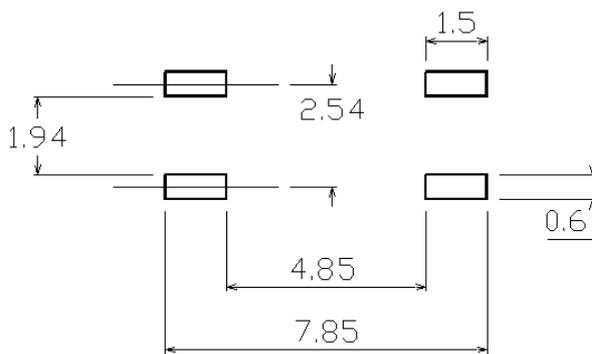
- MF3024 denotes Device Part Number
- I denotes Isocom
- Y denotes 1 digit Year code
- WW denotes 2 digit Week code

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PACKAGE DIMENSIONS (mm)

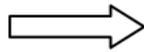
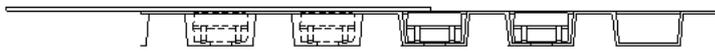
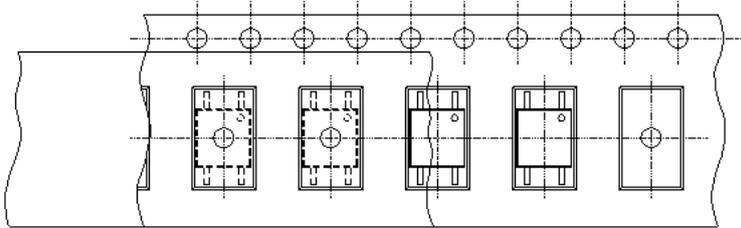


RECOMMENDED PAD LAYOUT (mm)

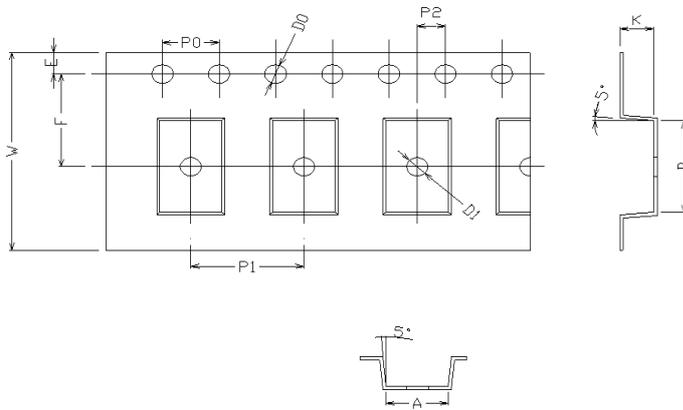


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TAPE AND REEL PACKAGING (mm)



Direction of feed from reel



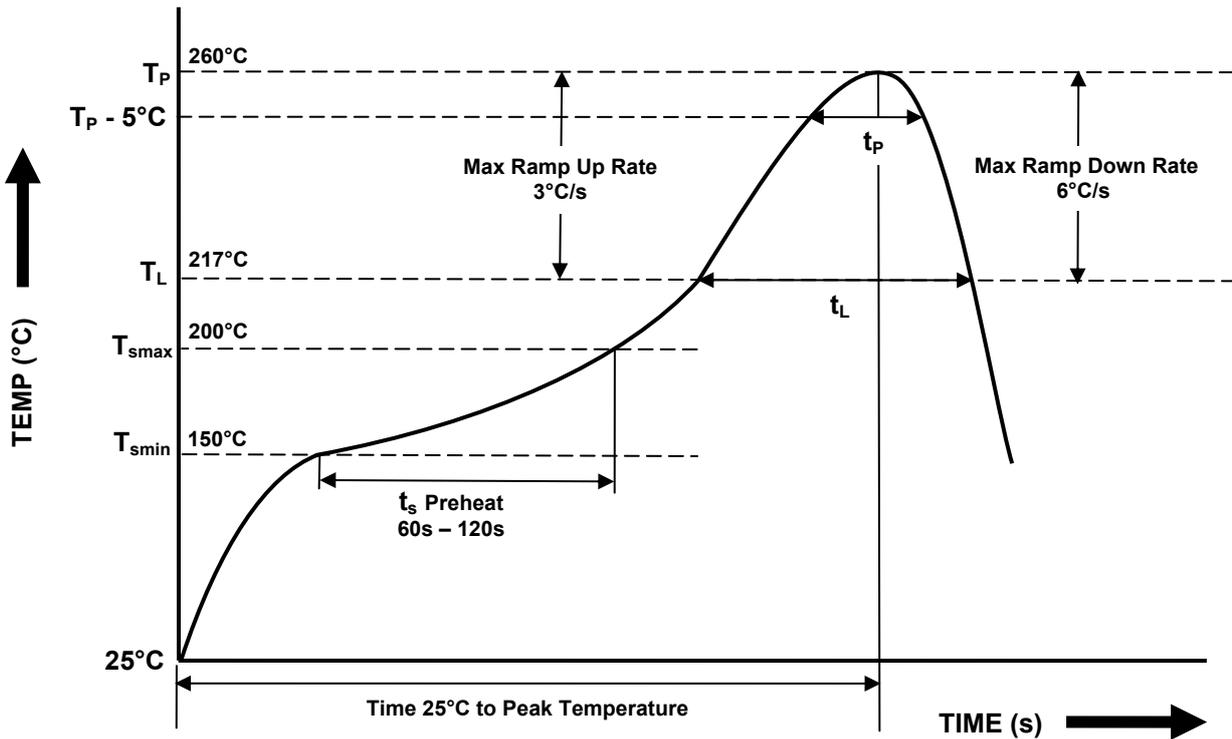
| | | | | | | |
|----------------|-----------|-----------|------------|-----------|----------|-----------|
| Dimension No. | A | B | D0 | D1 | E | F |
| Dimension(mm) | 4.4±0.1 | 7.4±0.1 | 1.5+0.1/-0 | 1.5±0.1 | 1.75±0.1 | 7.5±0.1 |
| Dimension No. | P0 | P1 | P2 | t | W | K0 |
| Dimension (mm) | 4.0±0.15 | 8.0±0.1 | 2.0±0.1 | 0.25±0.03 | 16.0±0.2 | 2.4±0.1 |

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IR REFLOW SOLDERING TEMPERATURE PROFILE

One Time Reflow Soldering is Recommended.

Do not immerse device body in solder paste.



| Profile Details | Conditions |
|---|---|
| Preheat - Min Temperature (T _{SMIN}) - Max Temperature (T _{SMAX}) - Time T _{SMIN} to T _{SMAX} (t _s) | 150°C 200°C 60s – 120s |
| Soldering Zone - Peak Temperature (T _P) - Liquidous Temperature (T _L) - Time within 5°C of Actual Peak Temperature (T _P – 5°C) - Time maintained above T _L (t _L) - Ramp Up Rate (T _L to T _P) - Ramp Down Rate (T _P to T _L) | 260°C 217°C 30s 60s – 100s 3°C/s max 6°C/s max |
| Average Ramp Up Rate (T _{smax} to T _P) | 3°C/s max |
| Time 25°C to Peak Temperature | 8 minutes max |



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